



4 IN-

Connection Diagram

V_{DD}

GND

IN+ 3

Automotive LVDS Differential Line Receiver

General Description

The DS90LT012AQ is a single CMOS differential line receiver designed for applications requiring ultra low power dissipation, low noise, and high data rates. The devices are designed to support data rates in excess of 400 Mbps (200 MHz) utilizing Low Voltage Differential Swing (LVDS) technology

The DS90LT012AQ accepts low voltage (350 mV typical) differential input signals and translates them to 3V CMOS output levels. The DS90LT012AQ includes an input line termination resistor for point-to-point applications.

The DS90LT012AQ and companion LVDS line driver DS90LV011AQ provide a new alternative to high power PECL/ECL devices for high speed interface applications.

(Top View)

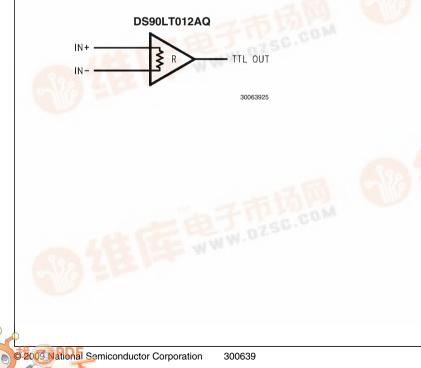
Features

DS90LT012AQ

- AECQ-100 Grade 1
- -40 to +125°C temperature range operation
- Compatible with ANSI TIA/EIA-644-A Standard
- >400 Mbps (200 MHz) switching rates
- 100 ps differential skew (typical)
- 3.5 ns maximum propagation delay
- Integrated line termination resistor (100Ω typical)
- Single 3.3V power supply design
- Power down high impedance on LVDS inputs
- LVDS inputs accept LVDS/CML/LVPECL signals
- Pinout simplifies PCB layout
- Low Power Dissipation (10mW typical@ 3.3V static)

Functional Diagram

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DS90LT012AQ Automotive LVDS Differential Line Receiver

July 29, 2009



Absolute Maximum Ratings (Note 4) IT Miniary Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V _{DD})	-0.3V to +4V
Input Voltage (IN+, IN-)	-0.3V to +3.9V
Output Voltage (TTL OUT)	–0.3V to (V _{DD} + 0.3V)
Output Short Circuit Current	-100mA
Maximum Package Power Dissi	pation @ +25°C
MF Package	794mW
Derate MF Package	7.22 mW/°C above +25°C
Package Thermal Resistance (4	-Layer, 2 oz. Cu, JEDEC)
θ_{JA}	138.5°C/W
θ _{JC}	107.0°C/W
Lead Temperature	
Soldering (4 sec.)	

Maximum Junction Temperature +135°C ESD Rating HBM (Note 1) >8 kV

>250V
>1250V

Note 1: Human Body Model, applicable std. JESD22-A114C Note 2: Machine Model, applicable std. JESD22-A115-A Note 3: Field Induced Charge Device Model, applicable std. JESD22-C101-C

Recommended Operating Conditions

	Min	Тур	Max	Units
Supply Voltage (V _{DD})	+3.0	+3.3	+3.6	V
Operating Free Air				
Temperature (T _A)	-40	25	+125	°C

Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified. (Notes 5, 6)

Symbol	Parameter	Conditions	Pin	Min	Тур	Max	Units
V _{TH}	Differential Input High Threshold	V_{CM} dependant on V_{DD}	IN+, IN–		-30	0	mV
V _{TL}	Differential Input Low Threshold]		-100	-30		mV
V _{CM}	Common-Mode Voltage	$V_{DD} = 3.0V$ to 3.6V, $V_{ID} = 100mV$		0.10		2.35	V
I _{IN}	Input Current	V _{IN} = +2.8V V _{DD} = 3.6V or 0V		-10	±1	+10	μA
		V _{IN} = 0V		-10	±1	+10	μA
		$V_{IN} = +3.6V$ $V_{DD} = 0V$		-20		+20	μA
I _{IND}	Differential Input Current	$V_{IN+} = +0.4V, V_{IN-} = +0V$		3	3.9	4.4	mA
R _T	Integrated Termination Resistor	$V_{IN+} = +2.4V, V_{IN-} = +2.0V$	-		100		Ω
C _{IN}	Input Capacitance	IN+ = IN- = GND			3		pF
V _{OH}	Output High Voltage	$I_{OH} = -0.4 \text{ mA}, V_{ID} = +200 \text{ mV}$	TTL OUT	2.4	3.1		V
		$I_{OH} = -0.4$ mA, Inputs terminated		2.4	3.1		V
		I _{OH} = -0.4 mA, Inputs shorted		2.4	3.1		V
V _{OL}	Output Low Voltage	I _{OL} = 2 mA, V _{ID} = -200 mV			0.3	0.5	V
I _{os}	Output Short Circuit Current	V _{OUT} = 0V (Note 7)		-15	-50	-100	mA
V _{CL}	Input Clamp Voltage	I _{CL} = -18 mA]	-1.5	-0.7		V
I _{DD}	No Load Supply Current	Inputs Open	V _{DD}		5.4	9	mA

Switching Characteristics 查询"DS90LT012AQ"供应商 Over Supply Voltage and Operating Temperature ranges, unless otherwise specified. (Notes 6, 8, 9, 10)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{PHLD}	Differential Propagation Delay High to Low	C _L = 15 pF	1.0	1.8	3.5	ns
t _{PLHD}	Differential Propagation Delay Low to High	V _{ID} = 200 mV	1.0	1.7	3.5	ns
t _{SKD1}	Differential Pulse Skew It _{PHLD} – t _{PLHD} I (Note 11)	(Figure 1 and Figure 2)	0	100	400	ps
t _{SKD3}	Differential Part to Part Skew (Note 12)		0	0.3	1.0	ns
t _{SKD4}	Differential Part to Part Skew (Note 13)		0	0.4	2.5	ns
t _{TLH}	Rise Time			350	800	ps
t _{THL}	Fall Time			175	800	ps
f _{MAX}	Maximum Operating Frequency (Note 14)			250		MHz

Note 4: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" specifies conditions of device operation.

Note 5: Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground unless otherwise specified (such as V_{ID}).

Note 6: All typicals are given for: $V_{DD} = +3.3V$ and $T_A = +25^{\circ}C$.

Note 7: Output short circuit current (I_{OS}) is specified as magnitude only, minus sign indicates direction only. Only one output should be shorted at a time, do not exceed maximum junction temperature specification.

Note 8: These parameters are guaranteed by design. The limits are based on statistical analysis of the device performance over PVT (process, voltage, temperature) ranges.

Note 9: C₁ includes probe and jig capacitance.

Note 10: Generator waveform for all tests unless otherwise specified: f = 1 MHz, $Z_0 = 50\Omega$, t_r and t_r (0% to 100%) $\leq 3 \text{ ns for IN±}$.

Note 11: t_{SKD1} is the magnitude difference in differential propagation delay time between the positive-going-edge and the negative-going-edge of the same channel.

Note 12: t_{SKD3}, part to part skew, is the differential channel-to-channel skew of any event between devices. This specification applies to devices at the same V_{DD} and within 5°C of each other within the operating temperature range.

Note 13: t_{SKD4}, part to part skew, is the differential channel-to-channel skew of any event between devices. This specification applies to devices over the recommended operating temperature and voltage ranges, and across process distribution. t_{SKD4} is defined as IMax – Minl differential propagation delay. **Note 14:** f_{MAX} generator input conditions: $t_r = t_f < 1$ ns (0% to 100%), 50% duty cycle, differential (1.05V to 1.35 peak to peak). Output criteria: 60%/40% duty cycle, V_{OL} (max 0.4V), V_{OH} (min 2.4V), load = 15 pF (stray plus probes).

Parameter Measurement Information

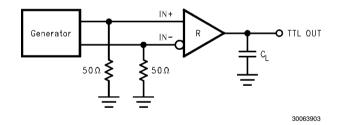


FIGURE 1. Receiver Propagation Delay and Transition Time Test Circuit

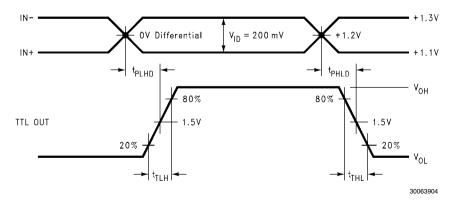


FIGURE 2. Receiver Propagation Delay and Transition Time Waveforms

DS90LT012AQ

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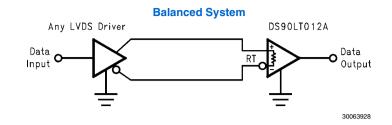


FIGURE 3. Point-to-Point Application (DS90LT012AQ)

Applications Information

General application guidelines and hints for LVDS drivers and receivers may be found in the following application notes: LVDS Owner's Manual (lit #550062-003), AN-808, AN-977, AN-971, AN-916, AN-805, AN-903.

LVDS drivers and receivers are intended to be primarily used in an uncomplicated point-to-point configuration as is shown in *Figure 3*. This configuration provides a clean signaling environment for the fast edge rates of the drivers. The receiver is connected to the driver through a balanced media which may be a standard twisted pair cable, a parallel pair cable, or simply PCB traces. Typically the characteristic impedance of the media is in the range of 100 Ω . The internal termination resistor converts the driver output (current mode) into a voltage that is detected by the receiver. Other configurations are possible such as a multi-receiver configuration, but the effects of a mid-stream connector(s), cable stub(s), and other impedance discontinuities as well as ground shifting, noise margin limits, and total termination loading must be taken into account.

The DS90LT012AQ differential line receiver is capable of detecting signals as low as 100 mV, over a ±1V common-mode range centered around +1.2V. This is related to the driver offset voltage which is typically +1.2V. The driven signal is centered around this voltage and may shift ±1V around this center point. The ±1V shifting may be the result of a ground potential difference between the driver's ground reference and the receiver's ground reference, the common-mode effects of coupled noise, or a combination of the two. The AC parameters of both receiver input pins are optimized for a recommended operating input voltage range of 0V to +2.4V (measured from each pin to ground). The device will operate for receiver input voltages up to $V_{\rm DD}$, but exceeding $V_{\rm DD}$ will turn on the ESD protection circuitry which will clamp the bus voltages.

POWER DECOUPLING RECOMMENDATIONS

Bypass capacitors must be used on power pins. Use high frequency ceramic (surface mount is recommended) 0.1μ F and 0.001μ F capacitors in parallel at the power supply pin with the smallest value capacitor closest to the device supply pin. Additional scattered capacitors over the printed circuit board will improve decoupling. Multiple vias should be used to connect the decoupling capacitors to the power planes. A 10μ F (35V) or greater solid tantalum capacitor should be connected at the power entry point on the printed circuit board between the supply and ground.

PC BOARD CONSIDERATIONS

Use at least 4 PCB board layers (top to bottom): LVDS signals, ground, power, TTL signals.

Isolate TTL signals from LVDS signals, otherwise the TTL signals may couple onto the LVDS lines. It is best to put TTL and LVDS signals on different layers which are isolated by a power/ground plane(s).

Keep drivers and receivers as close to the (LVDS port side) connectors as possible.

DIFFERENTIAL TRACES

Use controlled impedance traces which match the differential impedance of your transmission medium (ie. cable) and termination resistor. Run the differential pair trace lines as close together as possible as soon as they leave the IC (stubs should be < 10mm long). This will help eliminate reflections and ensure noise is coupled as common-mode. In fact, we have seen that differential signals which are 1mm apart radiate far less noise than traces 3mm apart since magnetic field cancellation is much better with the closer traces. In addition, noise induced on the differential lines is much more likely to appear as common-mode which is rejected by the receiver.

Match electrical lengths between traces to reduce skew. Skew between the signals of a pair means a phase difference between signals which destroys the magnetic field cancellation benefits of differential signals and EMI will result! (Note that the velocity of propagation, $v = c/E_r$, where c (the speed of light) = 0.2997mm/ps or 0.0118 in/ps). Do not rely solely on the autoroute function for differential traces. Carefully review dimensions to match differential impedance and provide isolation for the differential lines. Minimize the number of vias and other discontinuities on the line.

Avoid 90° turns (these cause impedance discontinuities). Use arcs or 45° bevels.

Within a pair of traces, the distance between the two traces should be minimized to maintain common-mode rejection of the receivers. On the printed circuit board, this distance should remain constant to avoid discontinuities in differential impedance. Minor violations at connection points are allowable.

TERMINATION

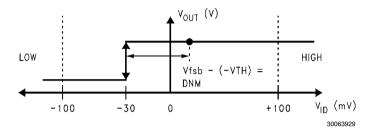
The DS90LT012AQ integrates the terminating resistor for point-to-point applications. The resistor value will be between 90 Ω and 133 Ω .

THRESHOLD

The LVDS Standard (ANSI/TIA/EIA-644-A) specifies a maximum threshold of ±100mV for the LVDS receiver. The DS90LT012AQ supports an enhanced threshold region of

-100mV to 0V. This is useful for fail-safe biasing. The threshold region is shown in the Voltage Traction Curve (VTC) in *Figure* 4. The typical DS90LT012AQLVDS receiver switches at about -30mV. Note that with $V_{ID} = 0V$, the output will be in a HIGH state. With an external fail-safe bias of +25mV applied, the typical differential noise margin is now the difference from the switch point to the bias point. In the example below, this would be 55mV of Differential Noise Margin (+25mV – (-30mV)). With the enhanced threshold region of -100mV to

0V, this small external fail-safe biasing of +25mV (with respect to 0V) gives a DNM of a comfortable 55mV. With the standard threshold region of $\pm 100mV$, the external fail-safe biasing would need to be +25mV with respect to +100mV or +125mV, giving a DNM of 155mV which is stronger fail-safe biasing than is necessary for the DS90LT012AQ. If more DNM is required, then a stronger fail-safe bias point can be set by changing resistor values.





FAIL SAFE BIASING

External pull up and pull down resistors may be used to provide enough of an offset to enable an input failsafe under open-circuit conditions. This configuration ties the positive LVDS input pin to VDD thru a pull up resistor and the negative LVDS input pin is tied to GND by a pull down resistor. The pull up and pull down resistors should be in the $5k\Omega$ to $15k\Omega$ range to minimize loading and waveform distortion to the driver. The common-mode bias point ideally should be set to approximately 1.2V (less than 1.75V) to be compatible with the internal circuitry. Please refer to application note AN-1194, "Failsafe Biasing of LVDS Interfaces" for more information.

PROBING LVDS TRANSMISSION LINES

Always use high impedance (> $100k\Omega$), low capacitance (< 2 pF) scope probes with a wide bandwidth (1 GHz) scope. Improper probing will give deceiving results.

CABLES AND CONNECTORS, GENERAL COMMENTS

When choosing cable and connectors for LVDS it is important to remember:

Use controlled impedance media. The cables and connectors you use should have a matched differential impedance of about 100Ω . They should not introduce major impedance discontinuities.

Balanced cables (e.g. twisted pair) are usually better than unbalanced cables (ribbon cable, simple coax) for noise reduction and signal quality. Balanced cables tend to generate less EMI due to field canceling effects and also tend to pick up electromagnetic radiation a common-mode (not differential mode) noise which is rejected by the receiver.

For cable distances < 0.5M, most cables can be made to work effectively. For distances $0.5M \le d \le 10M$, CAT 3 (category 3) twisted pair cable works well, is readily available and relatively inexpensive.

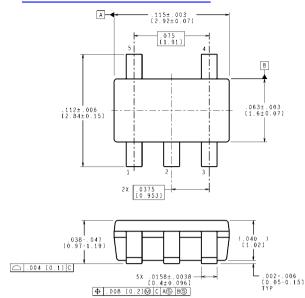
Pin Descriptions 查询"DS90LT012AQ"供应商

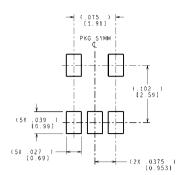
Package Pin Number	Pin Name	Description	
SOT23	Pin Name		
4	IN–	Inverting receiver input pin	
3	IN+	Non-inverting receiver input pin	
5	TTL OUT	Receiver output pin	
1	V _{DD}	Power supply pin, +3.3V \pm 0.3V	
2	GND	Ground pin	

Ordering Information

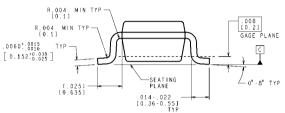
Operating Temperature	Package Type/ Number	Order Number
–40°C to +125°C	MF05A	DS90LT012AQMF

Physical Dimensions, inches (millimeters) unless otherwise noted 查询"DS90LT012AQ"供应商





LAND PATTERN RECOMMENDATION



CONTROLLING DIMENSION IS INCH VALUES IN [] ARE MILLIMETERS DIMENSIONS IN () FOR REFERENCE ONLY

5-Lead SOT23, JEDEC MO-178, 1.6mm Order Number DS90LT012AQMF NS Package Number MF05A

MF05A (Rev D)

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Notes

Pr	oducts	Design Support		
Amplifiers	www.national.com/amplifiers	WEBENCH® Tools	www.national.com/webench	
Audio	www.national.com/audio	App Notes	www.national.com/appnotes	
Clock and Timing	www.national.com/timing	Reference Designs	www.national.com/refdesigns	
Data Converters	www.national.com/adc	Samples	www.national.com/samples	
Interface	www.national.com/interface	Eval Boards	www.national.com/evalboards	
LVDS	www.national.com/lvds	Packaging	www.national.com/packaging	
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/green	
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts	
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality	
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback	
Voltage Reference	www.national.com/vref	Design Made Easy	www.national.com/easy	
PowerWise® Solutions	www.national.com/powerwise	Solutions	www.national.com/solutions	
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero	
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